

### General Description

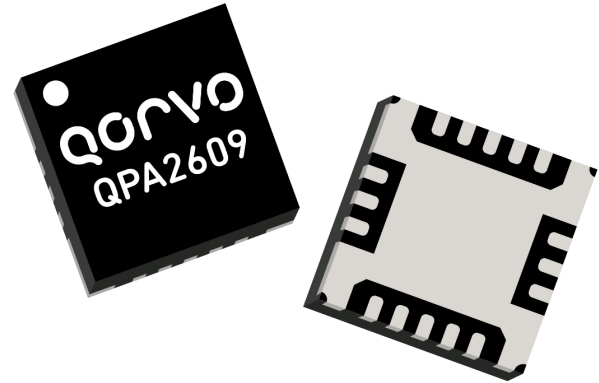
Qorvo’s QPA2609 is a packaged, high-performance, low noise amplifier fabricated on Qorvo’s production 90 nm pHEMT (QPHT09) process. Covering 7 – 14 GHz, the QPA2609 provides 26 dB small signal gain with a low noise figure of 1.1dB. The device can deliver 20dBm of power with P1dB of 18 dBm, while supporting an IM3 level of –50 dBc (at Pout=0 dBm / tone).

Packaged in a small 4 mm x 4 mm plastic overmold QFN, the QPA2609 is matched to 50 ohms with integrated DC blocking caps on both I/O ports for easy handling and simple system integration.

The QPA2609 high performance and ease of handling makes it an ideal component for satellite and point to point communication system applications.

Lead-free and RoHS compliant.

Evaluation boards are available upon request.



### Product Features

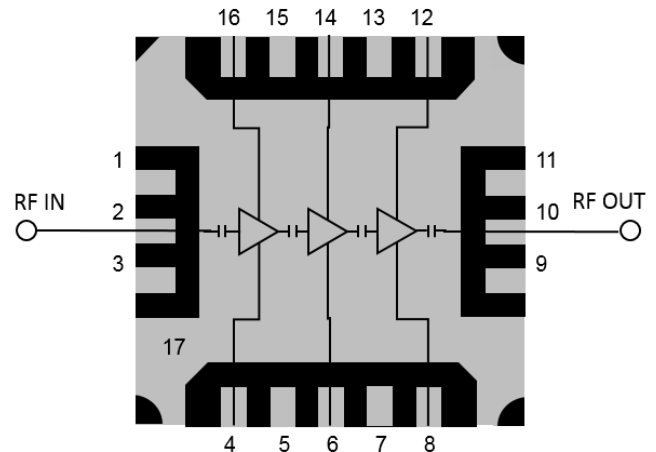
- Frequency Range: 7 – 14 GHz
- Noise Figure: 1.1 dB
- Small Signal Gain: 26 dB
- P1dB: 18 dBm
- IM3: –50 dBc (@ Pout=0 dBm/tone)
- Bias:  $V_D = 3.5\text{ V}$ ,  $I_{DQ} = 120\text{ mA}$ ,  $V_G = -0.46\text{ V}$
- Plastic Overmold Package
- Package Dimensions: 4.0 x 4.0 x 0.85 mm

*Performance is typical across frequency.  
Please reference electrical specification table and data plots for more details.*

### Applications

- Satellite Communications
- Point to Point Communications
- Radar

### Functional Block Diagram



### Ordering Information

Part No.	ECCN	Description
QPA2609S2	EAR99	QPA2609 Sample Bag, Qty 2
QPA2609SR	EAR99	QPA2609 Tape and Reel, Qty 100
QPA2609TR7	EAR99	QPA2609 Tape and Reel, Qty 750
QPA2609EVB1	EAR99	QPA2609 Evaluation Board

### Absolute Maximum Ratings

Parameter	Value
Drain Voltage (V <sub>D</sub> )	4.5 V
Drain Current (I <sub>D1</sub> /I <sub>D2</sub> /I <sub>D3</sub> )	96/115/192 mA
Gate Voltage Range	0 to -1.5 V
Gate Current (I <sub>G1</sub> /I <sub>G2</sub> /I <sub>G3</sub> at 125 °C)	5.0/5.0/6.6 mA
RF Input Power (50 Ω, 85 °C)	20 dBm
Channel Temperature, T <sub>CH</sub>	175 °C
Mounting Temperature (30 seconds)	260 °C
Storage Temperature	-55 to 150 °C

Operation of this device outside the parameter ranges given above may cause permanent damage. These are stress ratings only, and functional operation of the device at these conditions is not implied. Extended application of Absolute Maximum Rating conditions may reduce device reliability.

### Recommended Operating Conditions

Parameter	Value
Drain Voltage	3.5 V
Drain Current (quiescent, I <sub>DQ</sub> )	120 mA
Gate Voltage (typical)	-0.46 V
Operating Temperature Range	-40 to 85 °C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

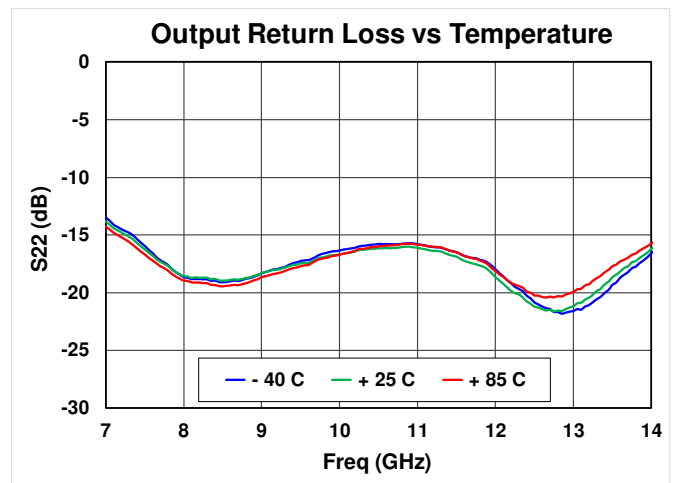
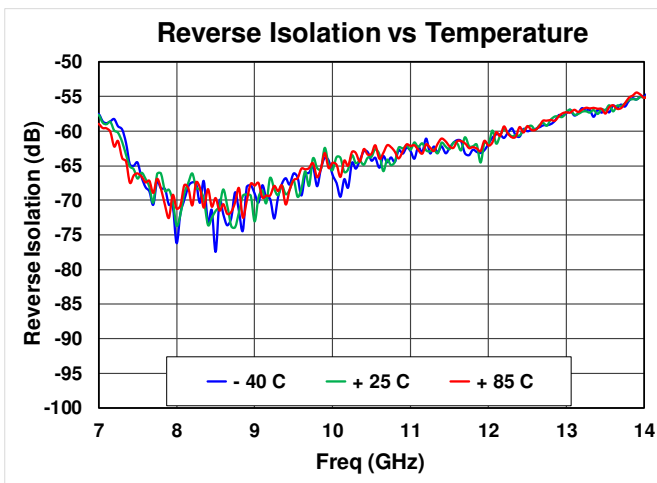
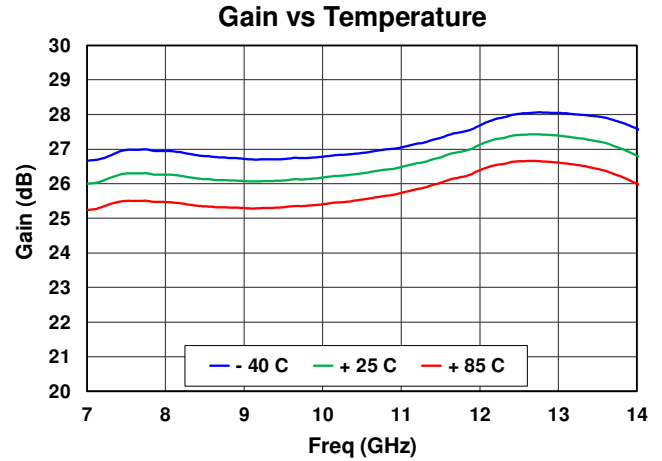
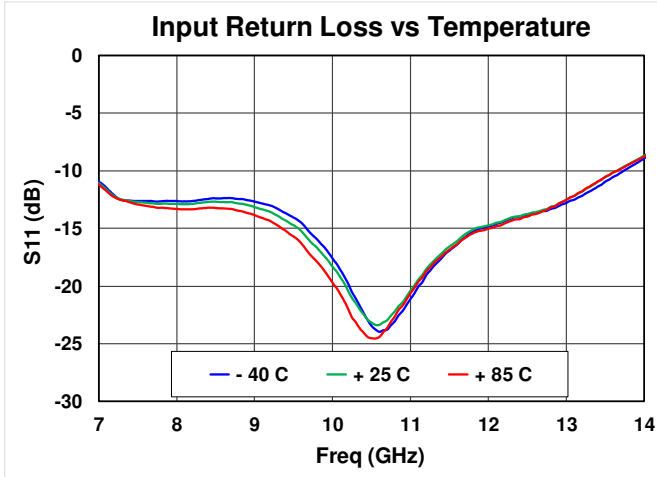
### Electrical Specifications

Test Conditions unless otherwise stated: V<sub>D</sub> = 3.5V, I<sub>DQ</sub> = 120mA, 25 °C. Data de-embedded to device reference planes

Parameter	Min	Typical	Max	Units
Frequency	7		14	GHz
Small Signal Gain		26		dB
Noise Figure		1.1		dB
1-dB Compression Point		18		dBm
Input Return Loss		12		dB
Output Return Loss		16		dB
3 <sup>RD</sup> Order Intermodulation level (P <sub>out</sub> =0 dBm/tone)		-50		dBc
Output TOI (P <sub>out</sub> =0 dBm/tone)		23		dBm
Gain Temperature Coefficient		-0.013		dB/°C

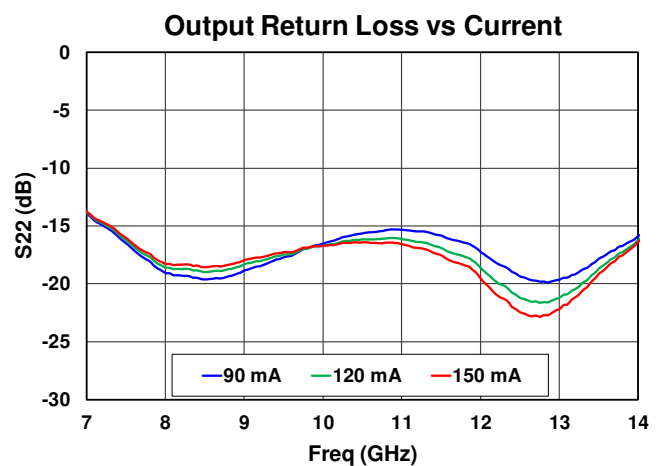
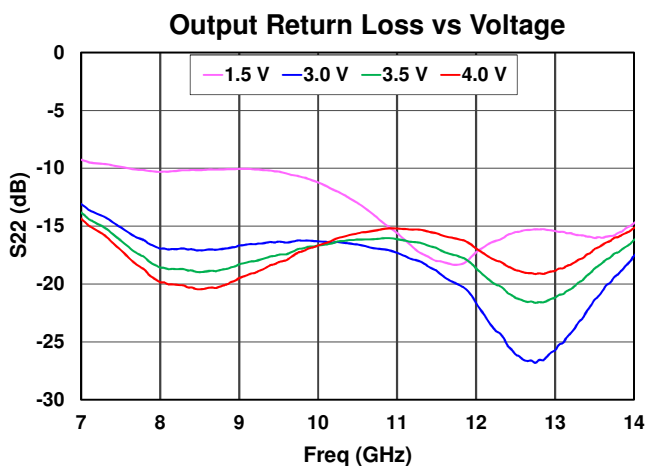
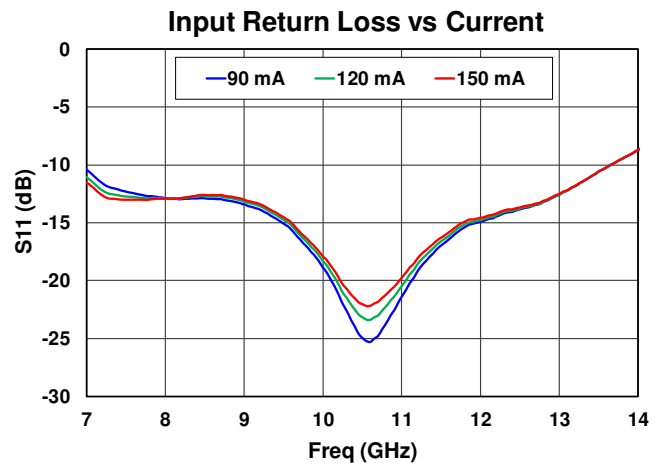
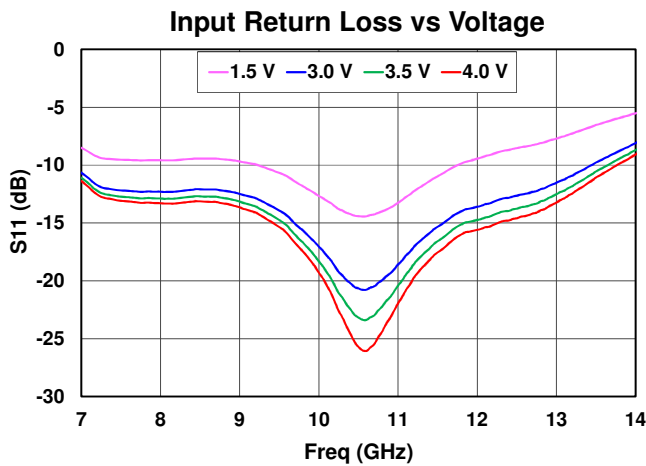
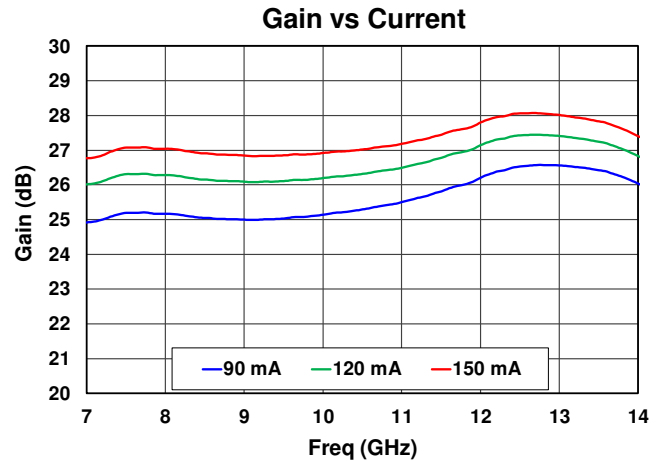
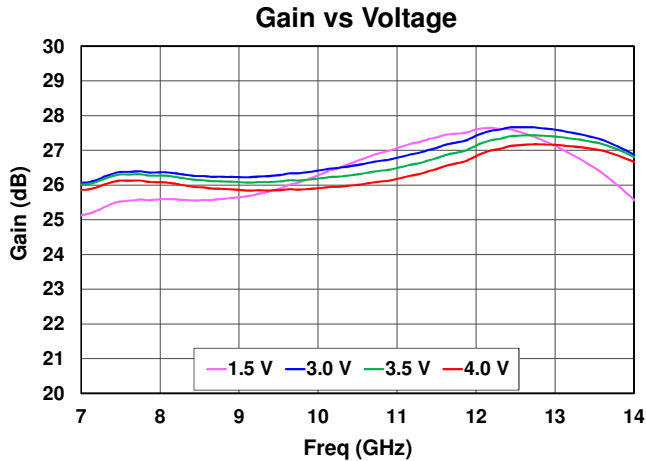
Performance Plots – Small Signal

Test Conditions unless otherwise stated:  $V_D = 3.5V$ ,  $I_{DQ} = 120mA$ ,  $25\text{ }^\circ C$ . Data de-embedded to device reference planes



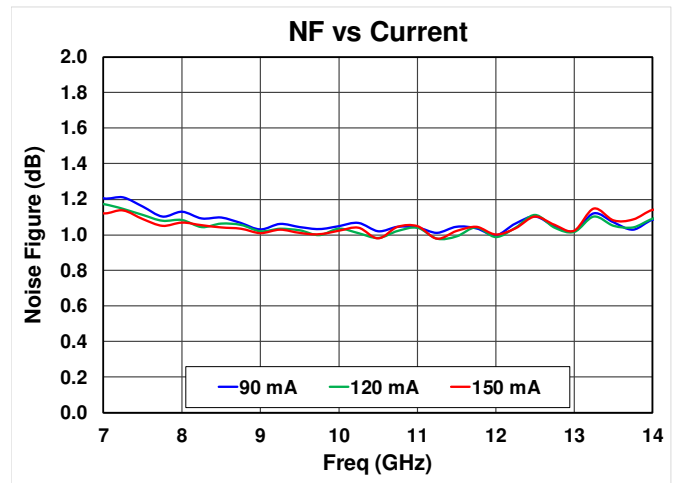
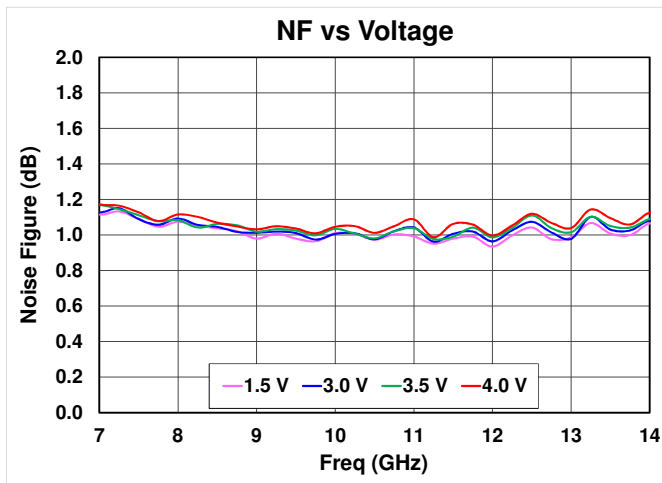
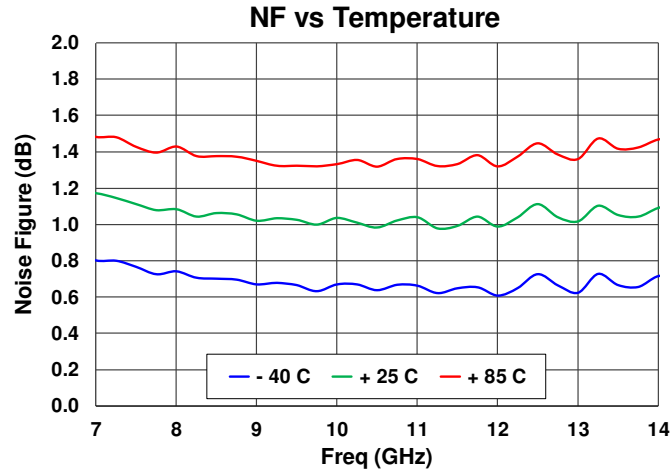
Performance Plots – Small Signal

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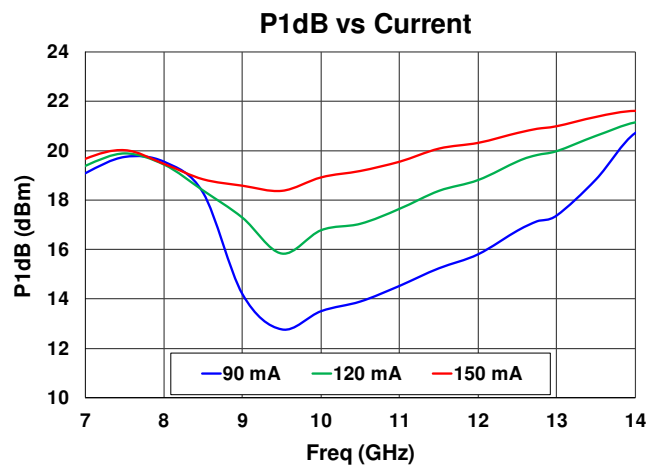
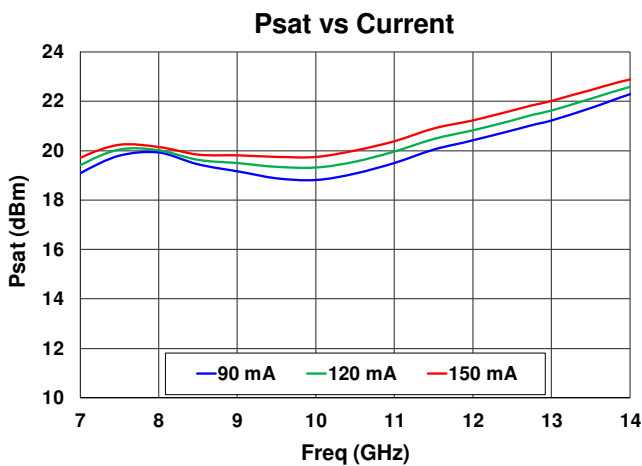
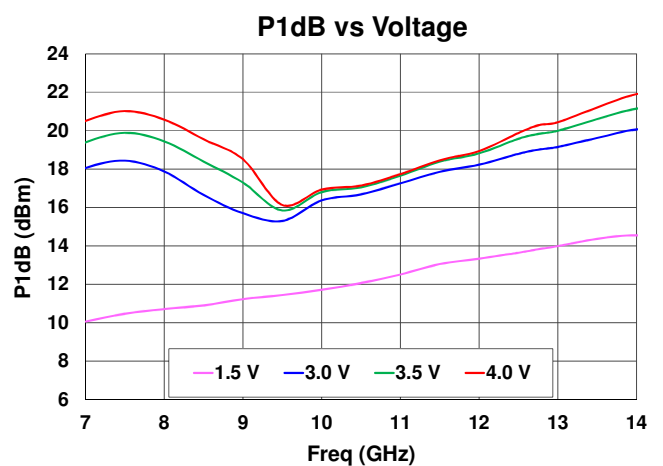
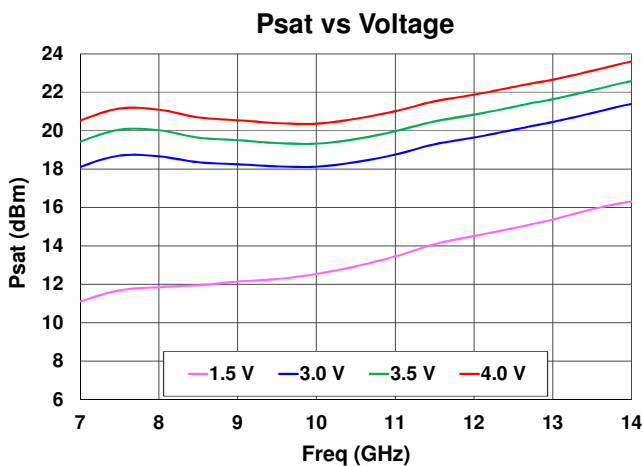
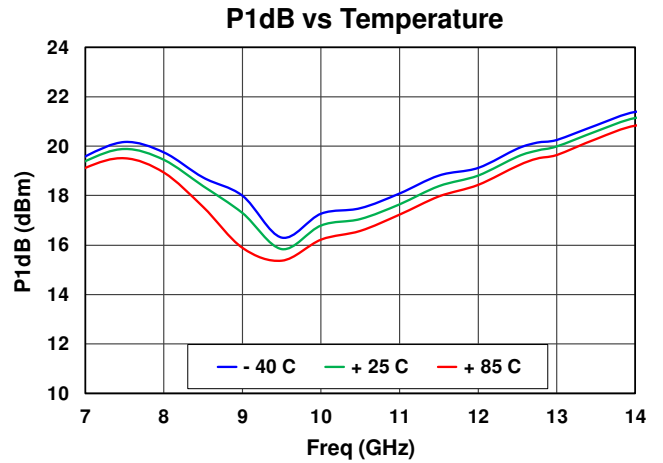
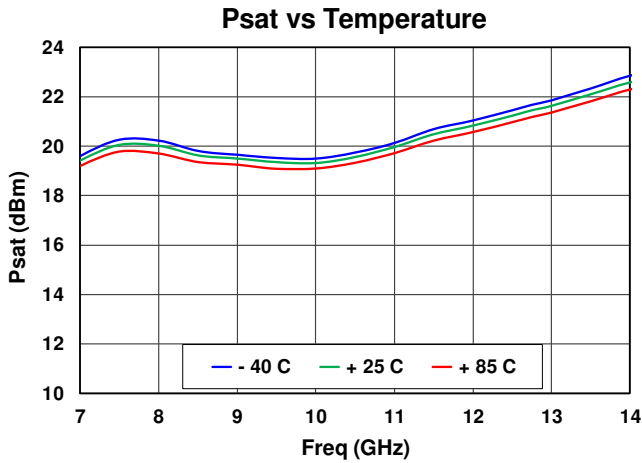
Performance Plots – Noise Figure

Test Conditions unless otherwise stated:  $V_D = 3.5V$ ,  $I_{DQ} = 120mA$ ,  $25\text{ }^\circ C$ . Data de-embedded to device reference planes



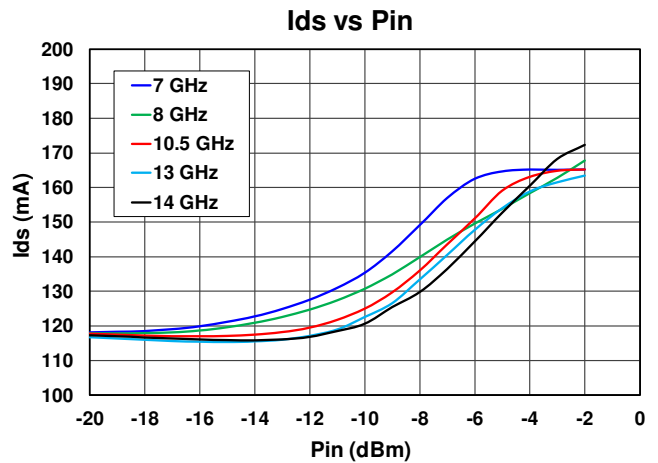
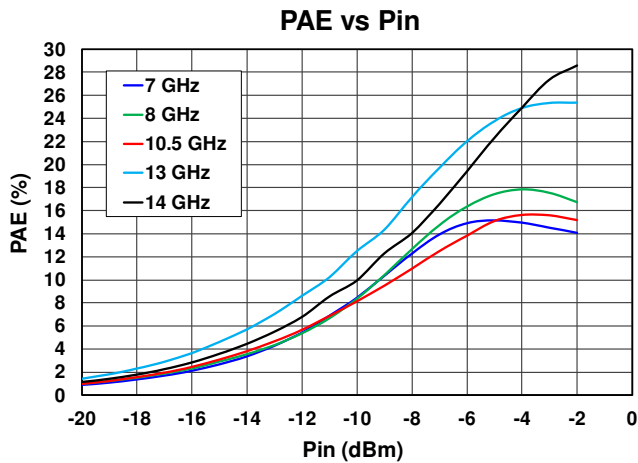
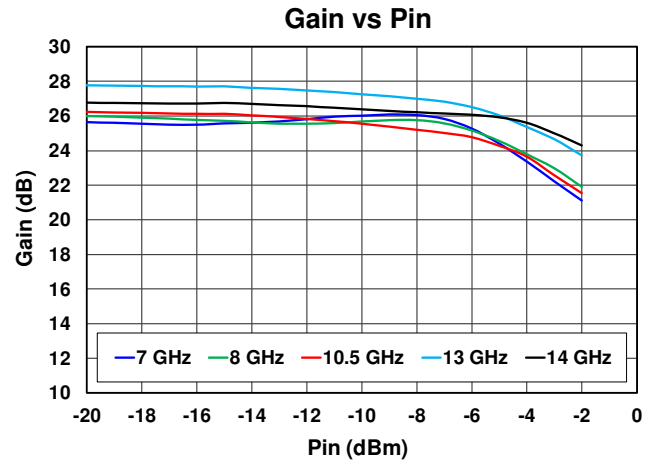
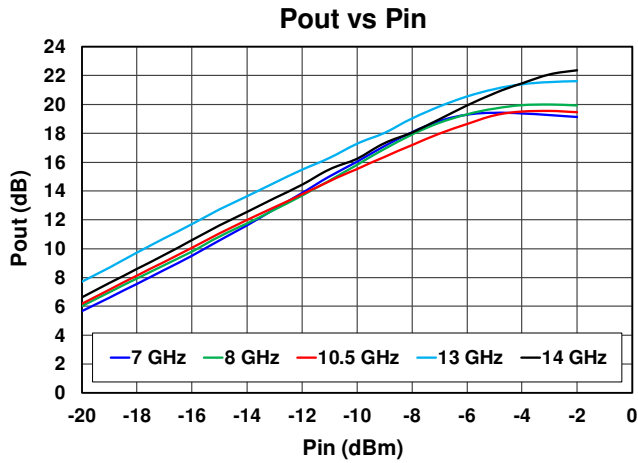
Performance Plots – Power

Test Conditions unless otherwise stated:  $V_D = 3.5V$ ,  $I_{DQ} = 120mA$ ,  $25\text{ }^\circ C$ . Data de-embedded to device reference planes



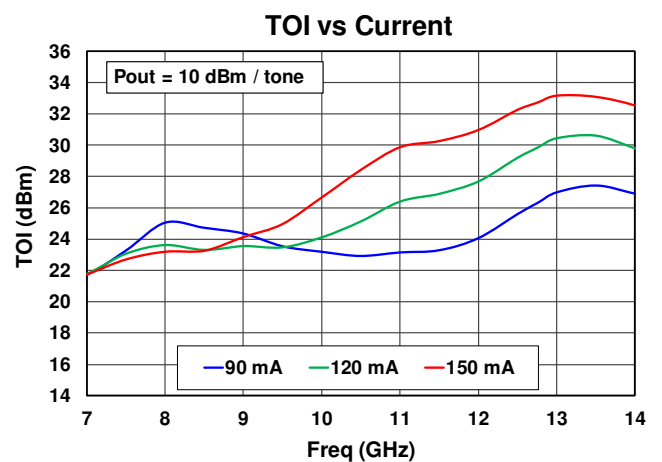
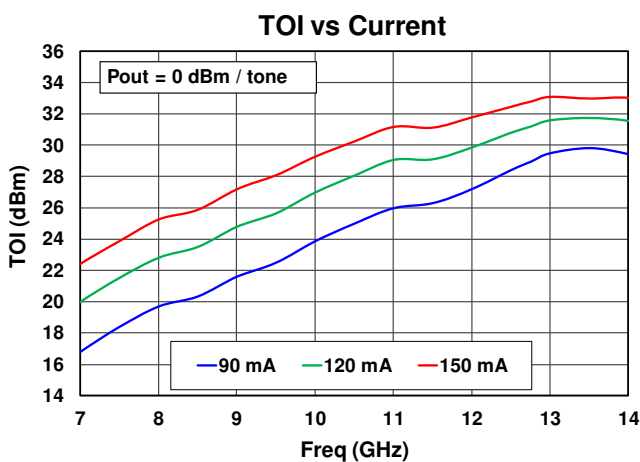
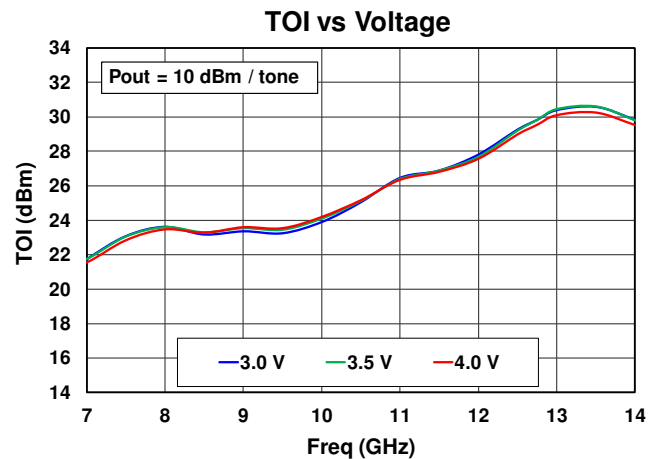
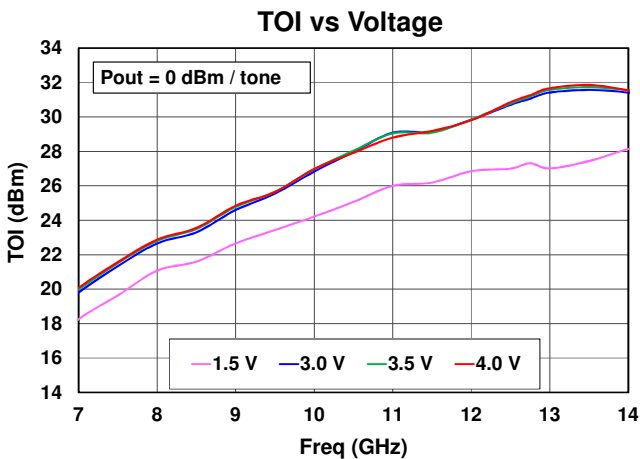
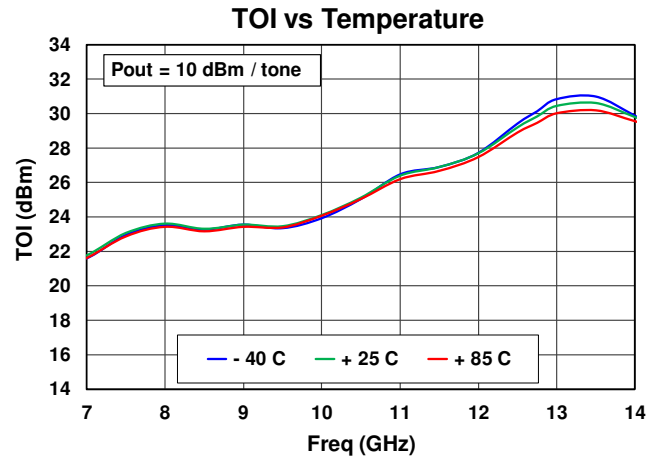
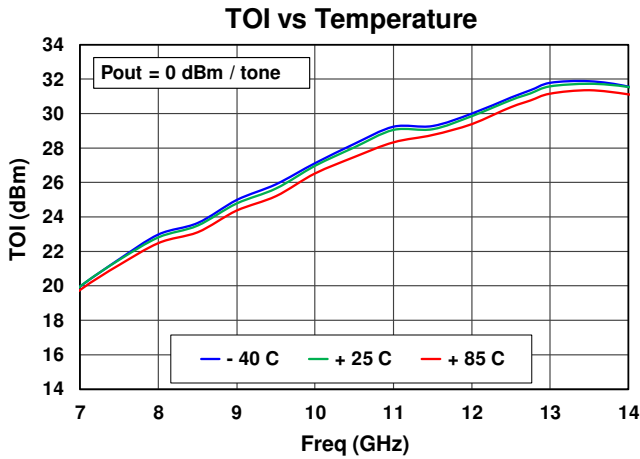
## Performance Plots – Power Sweep

Test Conditions unless otherwise stated:  $V_D = 3.5V$ ,  $I_{DQ} = 120mA$ ,  $25\text{ }^\circ C$ . Data de-embedded to device reference planes



Performance Plots – Linearity

Test Conditions unless otherwise stated:  $V_D = 3.5V$ ,  $I_{DQ} = 120mA$ ,  $\Delta f = 11\text{ MHz}$ ,  $25\text{ }^\circ\text{C}$ . Data de-embedded to device reference planes

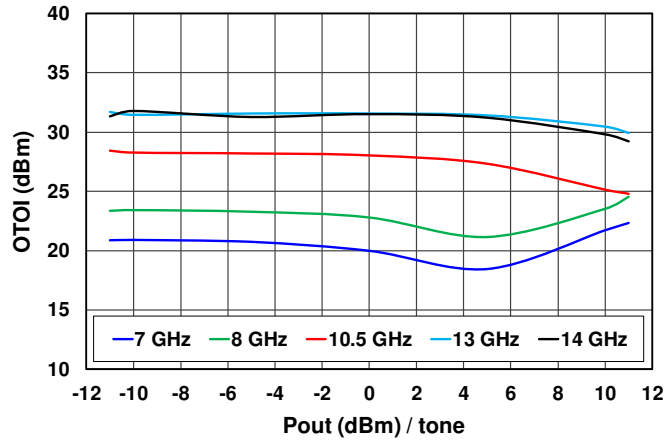




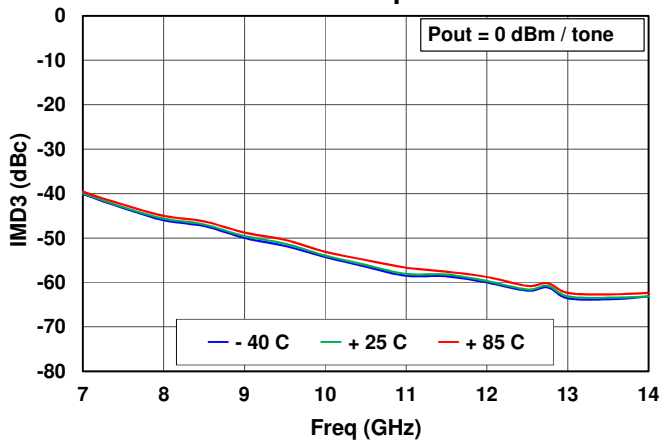
Performance Plots – Linearity

Test Conditions unless otherwise stated:  $V_D = 3.5V$ ,  $I_{DQ} = 120mA$ ,  $\Delta f = 11\text{ MHz}$ ,  $25\text{ }^\circ\text{C}$ . Data de-embedded to device reference planes

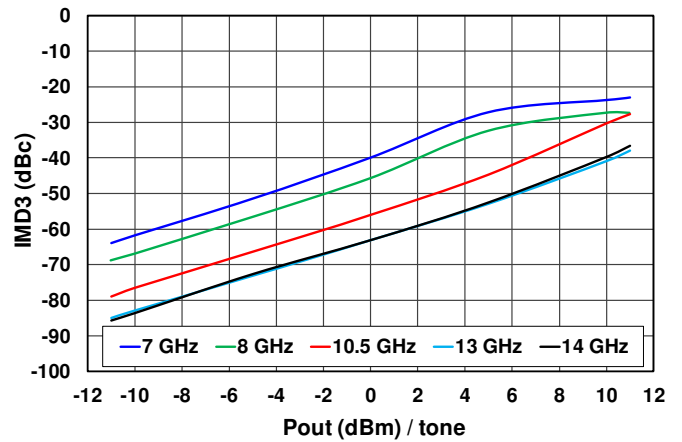
TOI vs Pout



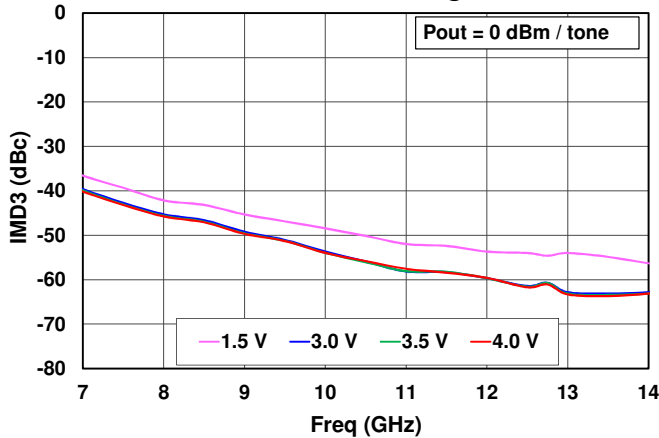
IMD3 vs Temperature



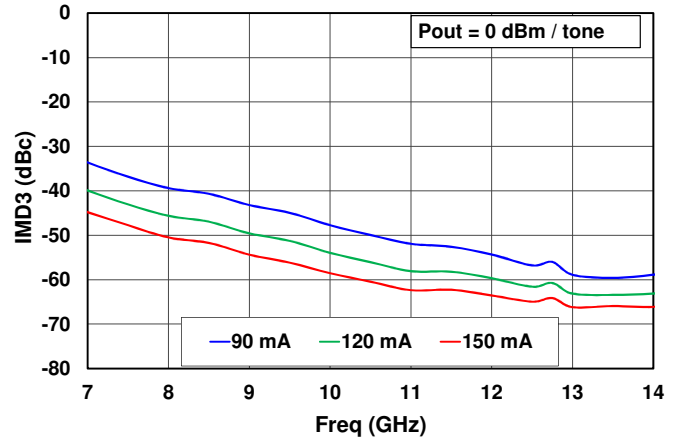
IMD3 vs Pout



IMD3 vs Voltage



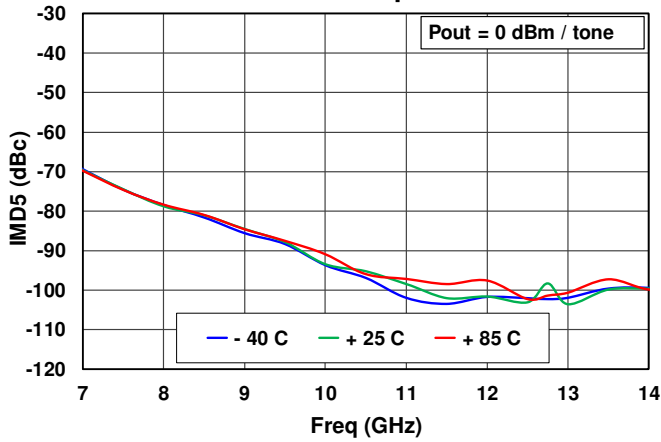
IMD3 vs Current



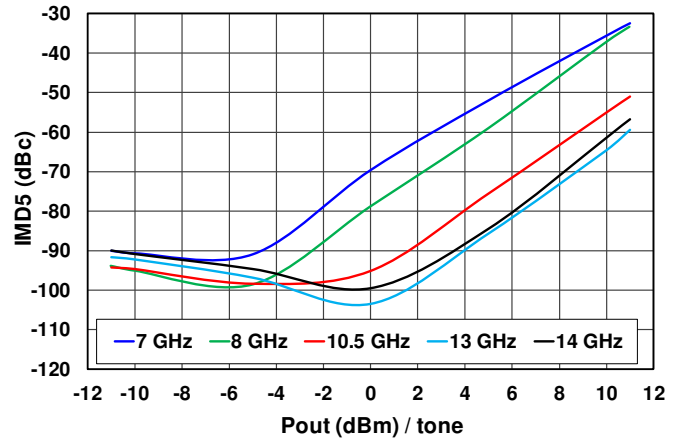
Performance Plots – Linearity

Test Conditions unless otherwise stated:  $V_D = 3.5V$ ,  $I_{DQ} = 120mA$ ,  $\Delta f = 11\text{ MHz}$ ,  $25\text{ }^\circ\text{C}$ . Data de-embedded to device reference planes

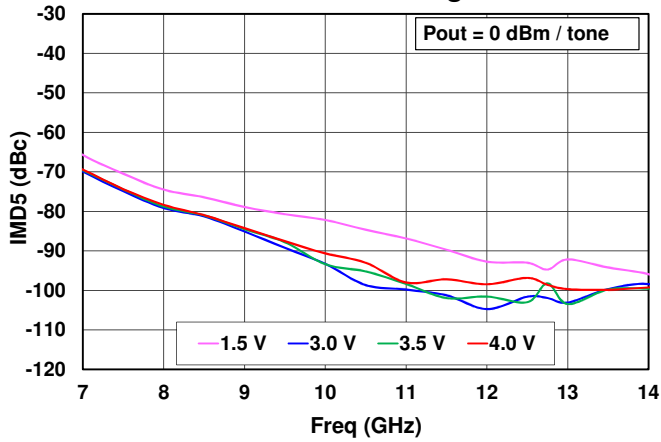
IMD5 vs Temperature



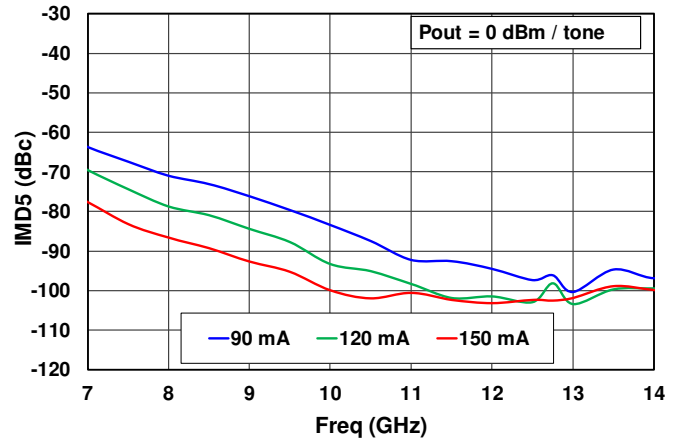
IMD5 vs Pout



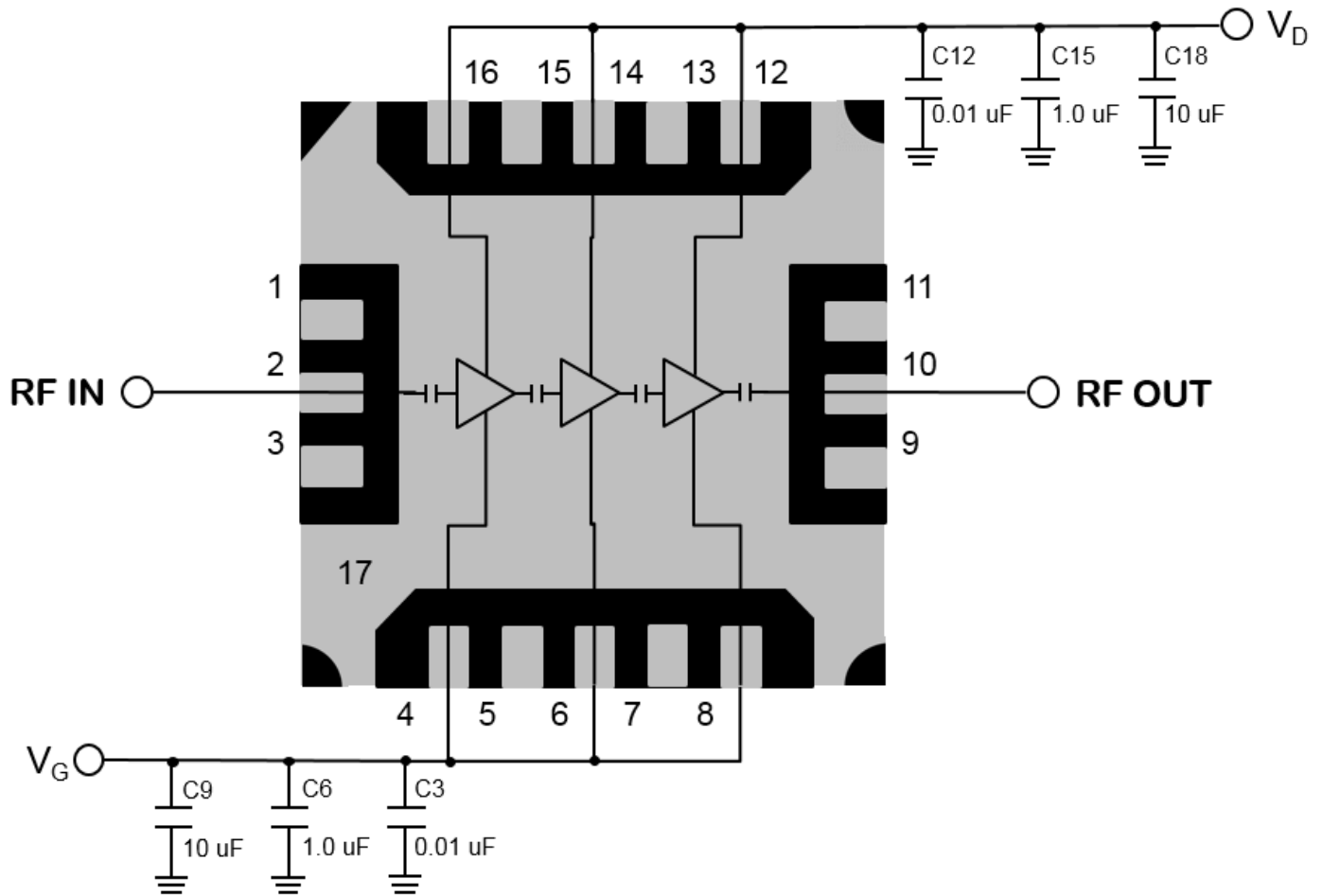
IMD5 vs Voltage



IMD5 vs Current



Application Circuit



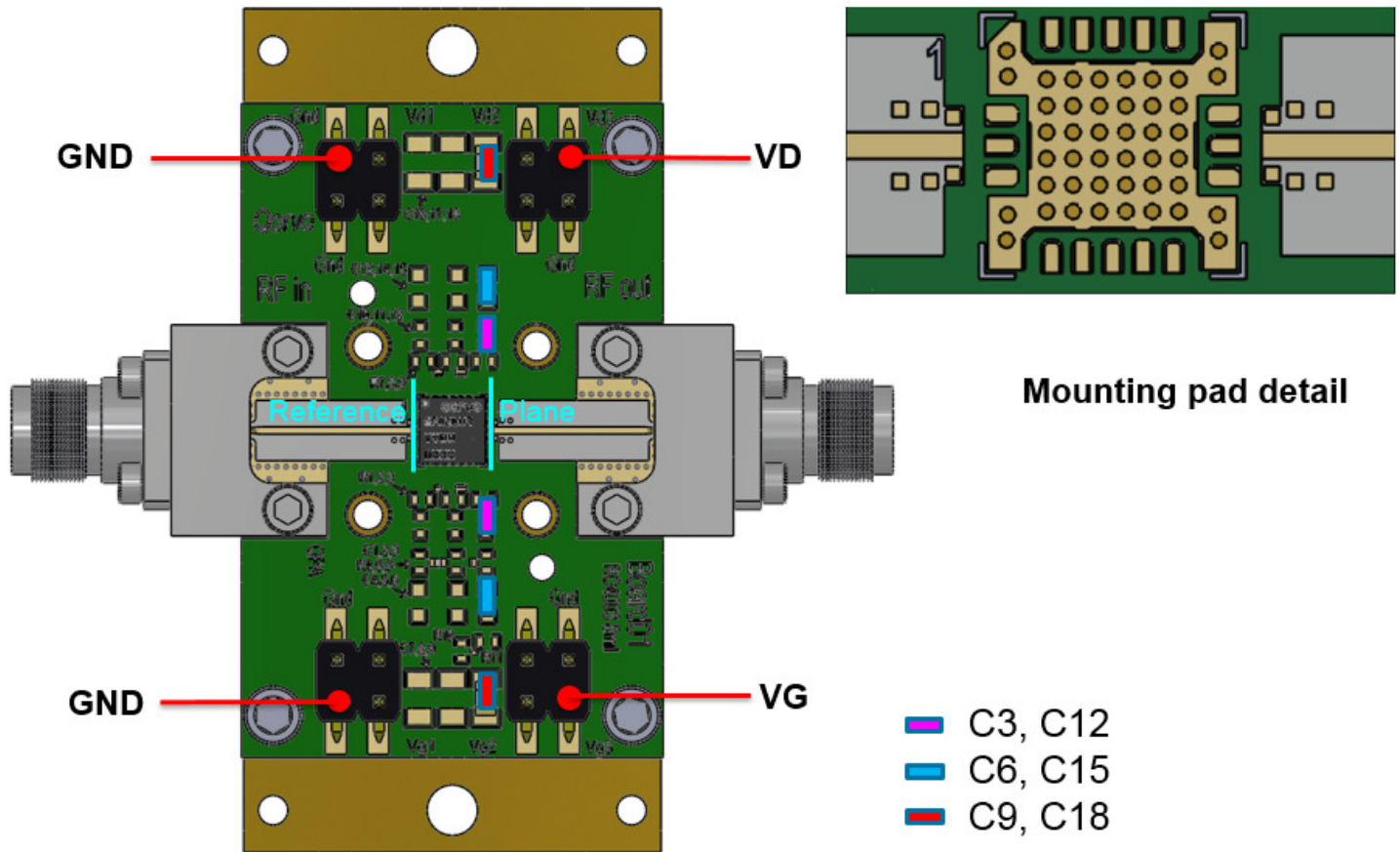
**Bias-up Procedure**

1. Set  $I_D$  limit to 200 mA,  $I_G$  limit to 10 mA
2. Set  $V_G$  to  $-1.5$  V
3. Set  $V_D$  +3.5 V
4. Adjust  $V_G$  more positive until  $I_{DQ} = 120$  mA ( $V_G \sim -0.46$  V Typical)
5. Apply RF signal

**Bias-down Procedure**

1. Turn off RF signal
2. Reduce  $V_G$  to  $-1.5$  V. Ensure  $I_{DQ} \sim 0$  mA
3. Set  $V_D$  to 0 V
4. Turn off  $V_D$  supply
5. Turn off  $V_G$  supply

#### Evaluation Board and Assembly

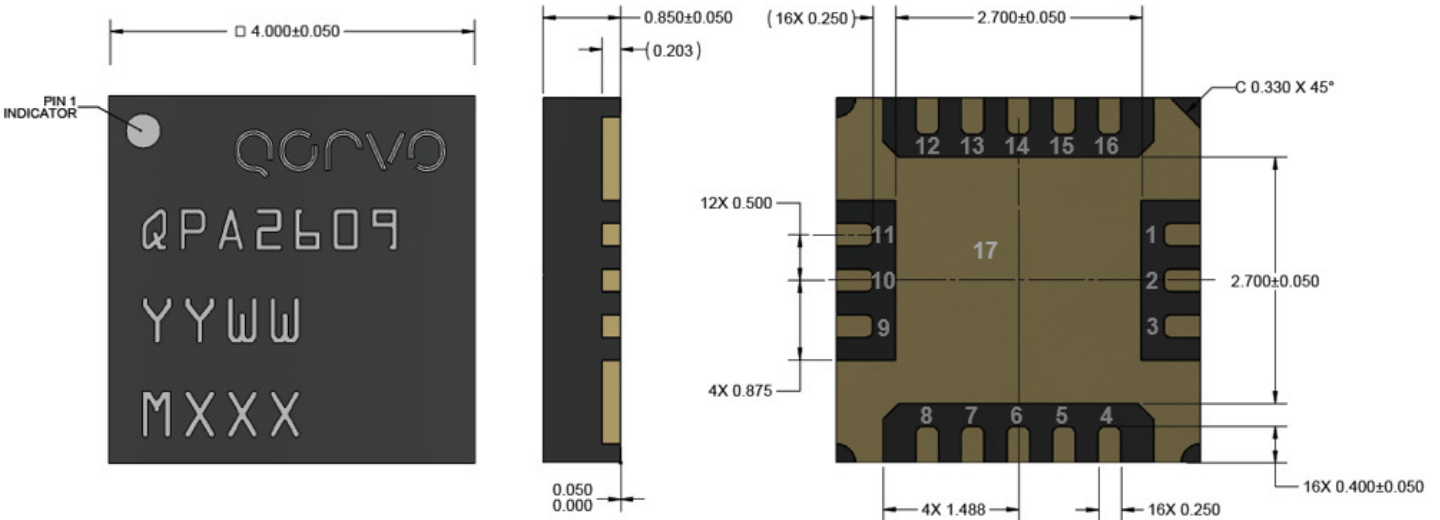


RF Layer is 0.008" thick Rogers Corp. RO4003C ( $\epsilon_r = 3.35$ ). Metal layers are 0.5 oz. copper. The microstrip line at the connector interface is optimized for the Southwest Microwave end launch connector 1092-01A-5.

#### Bill of Materials

Ref. Des.	Component	Value	Manuf.	Part Number
C3, C12	Surface Mount Cap.	CAP 0.01UF +/-10% 50V 0402 X7R ROHS	Various	
C6, C15	Surface Mount Cap.	CAP 1.0UF +/-10% 16V 0603 X7R ROHS	Various	
C9, C18	Surface Mount Cap.	CAP CER 10UF 10V X7R 10% 0805 TDK ROHS	Various	
J1, J2	RF Connector	2.92 MM RF CONNECTOR	Southwest Microwave	1092-01A-5

Mechanical Drawing & Pad Description



Dimensions in mm

Part Marking: 2609: Part Number, YY = Part Assembly Year, WW = Part Assembly Week, MXXX = Batch ID

Pin Number	Label	Description
1, 3, 9, 11, 17 (slug)	GND	GROUND
2	RF Input	Matched to 50 ohms, DC blocked
4	VG1	Gate Voltage; bias network is required ( $V_G$ can be tied together at PCB)
6	VG2	Gate Voltage; bias network is required ( $V_G$ can be tied together at PCB)
8	VG3	Gate Voltage; bias network is required ( $V_G$ can be tied together at PCB)
10	RF Output	Matched to 50 ohms, DC blocked
12	VD3	Drain Voltage; bias network is required ( $V_D$ can be tied together at PCB)
14	VD2	Drain Voltage; bias network is required ( $V_D$ can be tied together at PCB)
16	VD1	Drain Voltage; bias network is required ( $V_D$ can be tied together at PCB)
5, 7, 13, 15	N/C	No internal connection. Recommend to GND at the PCB level

## Thermal and Reliability Information

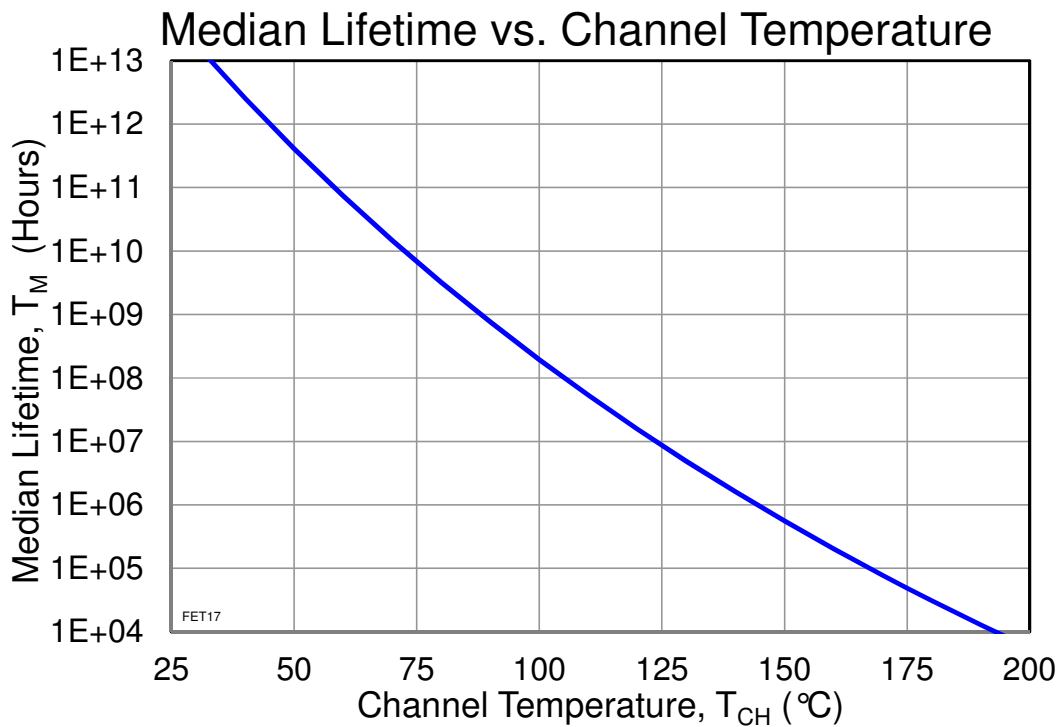
Parameter	Test Conditions	Value	Units
Thermal Resistance ( $\theta_{JC}$ ) <sup>(1)</sup>	$T_{base} = 85^\circ\text{C}$ , $V_D = 3.5\text{ V}$ , $I_{DQ} = 120\text{ mA}$ Quiescent / Small Signal operation $P_{DISS} = 0.42\text{ W}$	47.6	$^\circ\text{C/W}$
Channel Temperature ( $T_{CH}$ )		105	$^\circ\text{C}$
Median Lifetime ( $T_M$ )		4.0E07	Hrs

Notes:

- Thermal resistance is measured to back of the package.

## Median Lifetime

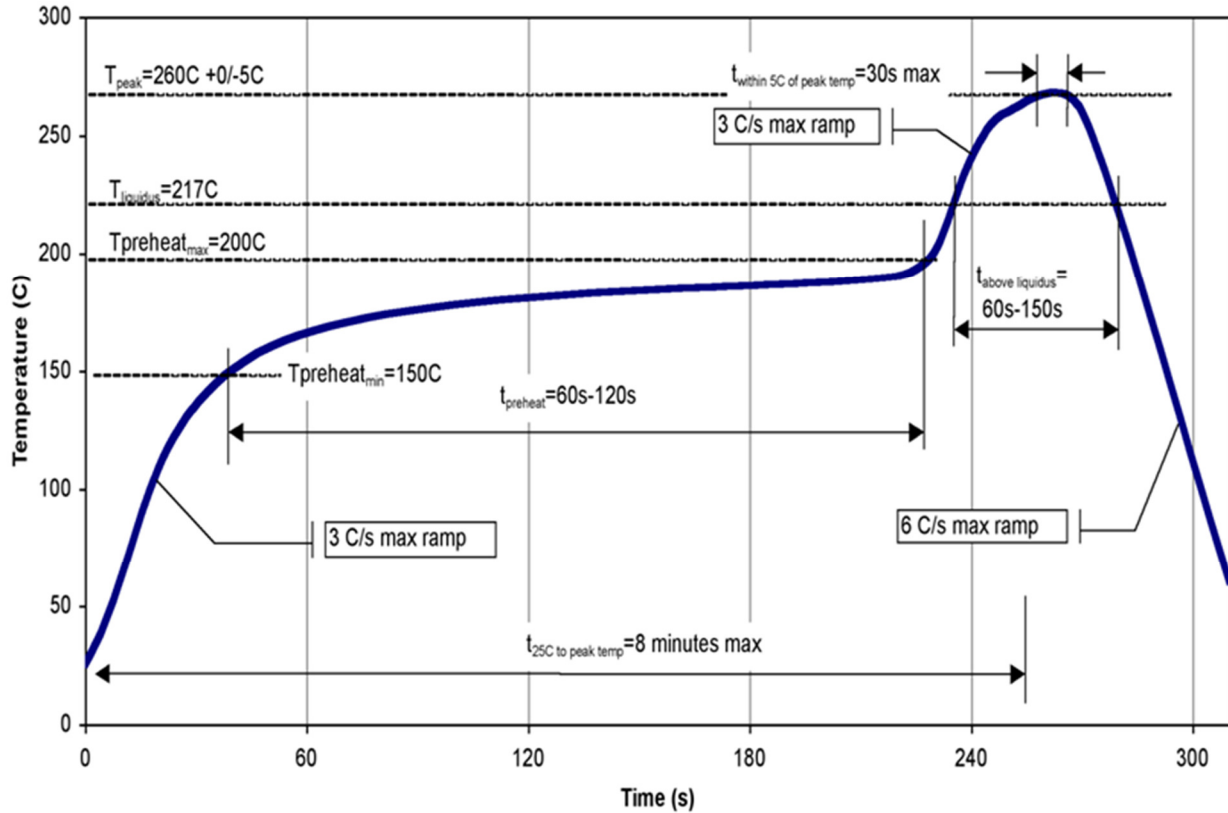
Test Conditions:  $V_D = 4\text{ V}$   
 Failure Criteria = 10% reduction in  $I_{D\_MAX}$



## Solderability

Compatible with the latest version of J-STD-020, Lead-free solder, 260 °C

## Recommended Soldering Temperature Profile



## Handling Precautions

Parameter	Rating	Standard
ESD – Human Body Model (HBM)	Class 1A	ESDA / JEDEC JS-001-2012
ESD – Charged Device Model (CDM)	TBD	ESDA / JEDEC JS-002-2014
MSL – Convection Reflow 260 °C	Level 3	JEDEC standard IPC/JEDEC J-STD-020



Caution!  
ESD-Sensitive Device

## RoHS Compliance

This product is compliant with the 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment), as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C<sub>15</sub>H<sub>12</sub>Br<sub>4</sub>O<sub>2</sub>) Free
- PFOS Free
- SVHC Free
- Qorvo Green

## Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

**Tel:** 1-844-890-8163

**Web:** [www.qorvo.com](http://www.qorvo.com)

**Email:** [customer.support@qorvo.com](mailto:customer.support@qorvo.com)

For technical questions and application information: **Email:** [appsupport@qorvo.com](mailto:appsupport@qorvo.com)

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